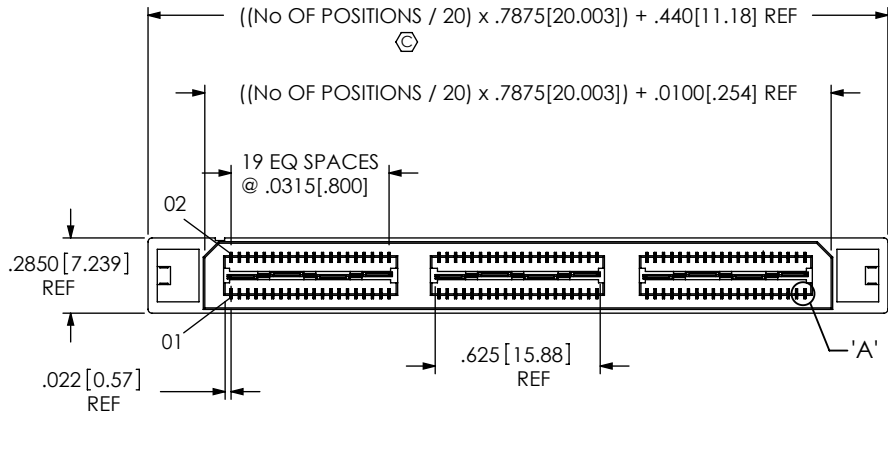


DO NOT SCALE FROM THIS PRINT

QSE-XXX-01-X-D-EMX-XX



No OF POSITIONS
 -020, -040, -060
 **-.080 **-.100
 (PER ROW)
 LEAD STYLE
 -01: .1380 [3.505]

OPTION
 * -GP: GUIDE POST (60 POS MAX)
 (SEE FIG 2, SEE SHEET 2)
 -TY: TRAY PACKAGING
 * EM3-GP = NOT TOOLED
 EDGE MOUNT THICKNESS
 -EM2: .064[1.63] +/- .004 PCB
 (USE QSE-20-01-D-EM2-XX & C-162-01-X)
 -EM3:
 (USE QSE-20-01-D-EM3-XX & C-162-02-X)
 (SEE NOTE 10)

PLATING SPECIFICATION
 PLATING THICKNESSES ARE FOR SIGNAL PINS ONLY. FOR GROUND PLANE THICKNESSES, SEE PP-T-1G13-XX-X.
 -F: 3μ" FLASH SELECTIVE GOLD IN CONTACT AREA MATTE TIN ON TAIL (SEE NOTE 6)
 (USE C-162-XX-F & T-1G13-01-F)
 -L: 10μ" LIGHT SELECTIVE GOLD IN CONTACT AREA WITH MATTE TIN ON TAIL
 (USE C-162-XX-L & T-1G13-01-L)
 -H: 30μ" HEAVY GOLD IN CONTACT AREA 3μ" FLASH GOLD ON TAILS
 (USE C-162-XX-H & T-1G13-01-G)
 -TL: TIN/LEAD (90/10±5%) CONTACT AND TAIL
 -S: 30μ" SELECTIVE GOLD IN CONTACT AREA, MATTE TIN ON TAIL
 (USE C-162-XX-S & T-1G13-01-L)

ROW SPECIFICATION
 -D: DOUBLE (USE QSE-20-01-D-EMX-XX)
 No OF BANKS
 * = SEE NOTE 10
 ** = SEE NOTE 13

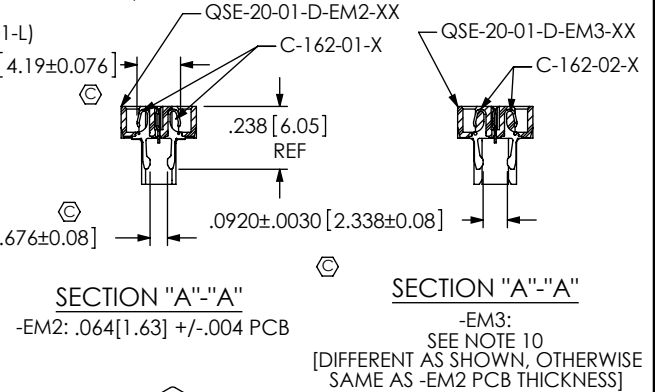
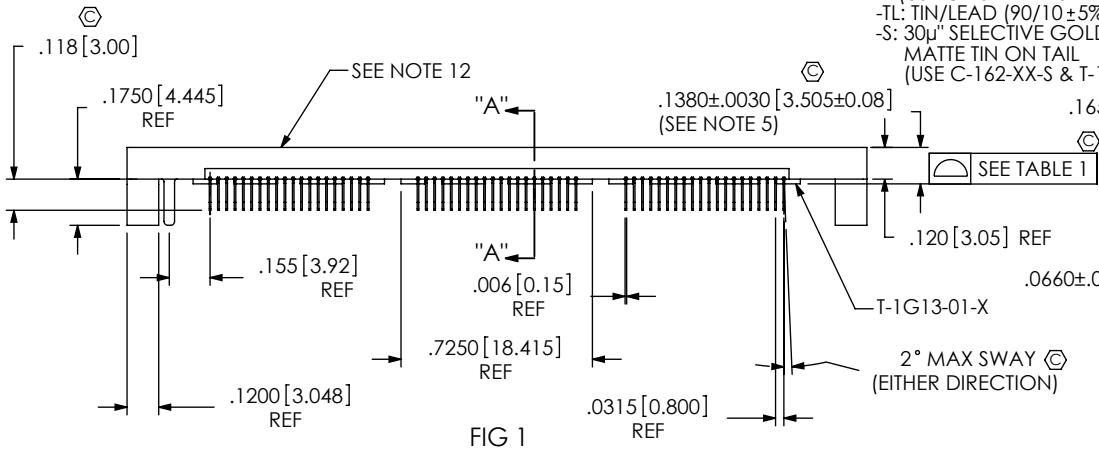


FIG 1

TABLE 1

No OF POSITIONS	GND PLANE COPLANARITY	ASSEMBLY BOW
-020 THRU -060	.004 [0.10]	.004 [0.10]
**-.080 THRU **-.100	.005[1.27]	.006[0.15]

** = SEE NOTE 13

- NOTES:
1. Ⓢ REPRESENTS A CRITICAL DIMENSION.
 2. MINIMUM CONTACT RETENTION: 6 OZ
 3. MINIMUM GROUND PLANE RETENTION: 8 OZ
 4. PARTS ARE MOLD TO POSITION.
 5. MAXIMUM VARIANCE OF .002[0.05]
 6. -L PLATING CAN BE SUBSTITUTED FOR -F PLATING.
 7. NOTE DELETED.
 8. BOARD THICKNESS TO BE MEASURED FROM SOLDER PAD TO SOLDER PAD.
 9. SEE WWW.SAMTEC.COM/PROCESSING/EDGEMOUNT_TECTALK/INDEX.HTM FOR INFORMATION ON PROCESSING EDGEMOUNT PARTS TO BOARDS.
 10. -EM3 IS NOT A STANDARD OFFERING; AVAILABLE AS AN ASP ONLY. PLEASE CONTACT SAMTEC INTERCONNECT PROCESSING GROUP WITH ORDER INQUIRIES
 11. NOTE DELETED.
 12. SIDE WALLS ARE RIBBED AS NECESSARY TO CONTROL BOW.
 13. AVAILABLE FOR EXISTING CUSTOMERS ONLY.

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN INCHES.
 TOLERANCES ARE:
 DECIMALS ANGLES
 .XX: ±.01[.3] 2°
 .XXX: ±.005[.13]
 .XXXX: ±.0020[.051]

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520 PARK EAST BLVD. NEW ALBANY, IN 47150
 PHONE: 812-944-6733 FAX: 812-948-5047
 e-Mail info@SAMTEC.com code 55322

DESCRIPTION:
 .8mm EDGE MOUNT HS SOCKET ASSEMBLY

DWG. NO.
 QSE-XXX-01-X-D-EMX-XX

BY: DEAN P 5/24/2000 SHEET 1 OF 2

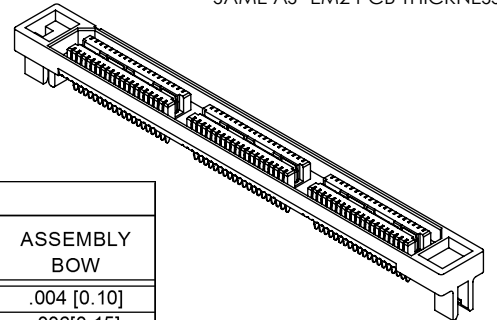
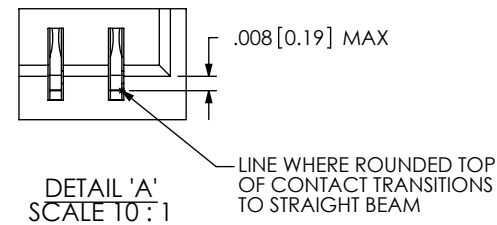
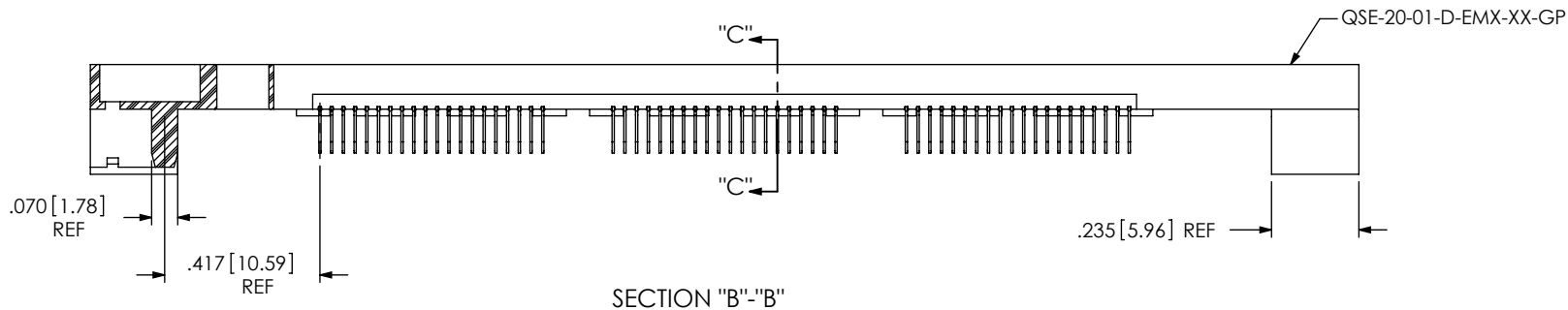
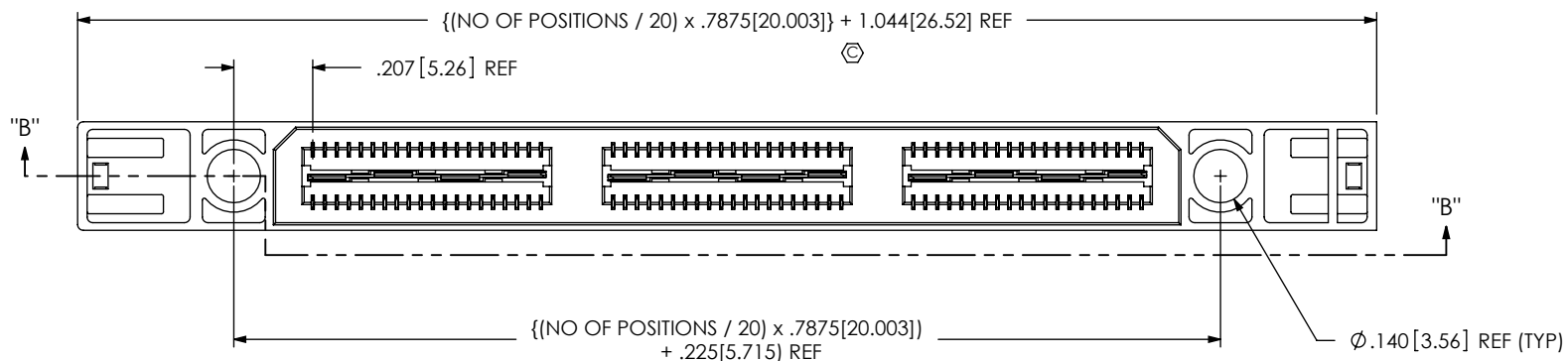


FIG 2

-GP: GUIDE POST
 (DIFFERENT AS SHOWN, OTHERWISE SAME AS FIG 1)
 (60 POSITION MAX)
 (ONLY AVAILABLE WITH -EM2 OPTION)



CRITICAL DIMENSION INSPECTION INSTRUCTION TABLE	
ASSEMBLY OPERATION	IN-PROCESS INSPECTION
FILL C-162-XX-X	C1, C2, C4*, C5*, C7, C8
FILL T-1G13-01-X	C6
WHERE APPLICABLE *	

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	<p>520 PARK EAST BLVD., NEW ALBANY, IN 47150 PHONE: 812-944-6733 FAX: 812-948-5047 e-Mail info@SAMTEC.com code 55322</p>
	<p>DESCRIPTION: .8mm EDGE MOUNT HS SOCKET ASSEMBLY</p>
	<p>DWG. NO. QSE-XXX-01-X-D-EMX-XX</p>
<p>BY: DEAN P 5/24/2000</p>	<p>SHEET 2 OF 2</p>